

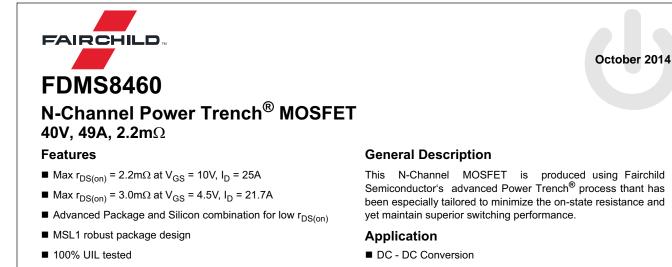
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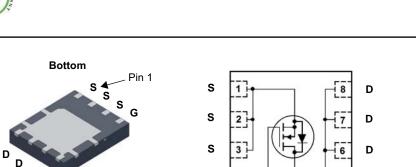


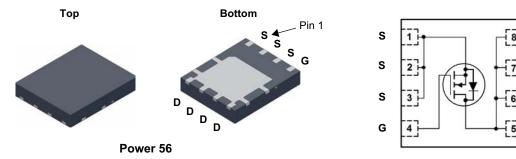
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MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			40	V	
V _{GS}	Gate to Source Voltage			±20	V	
Ι _D	Drain Current -Continuous (Package limited)	T _C = 25°C		49		
	-Continuous (Silicon limited)	T _C = 25°C		167	_	
	-Continuous	T _A = 25°C	(Note 1a)	25	A	
	-Pulsed			160		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	864	mJ	
P _D	Power Dissipation	T _C = 25°C		104	w	
	Power Dissipation	T _A = 25°C	(Note 1a)	2.5	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

RoHS Compliant

$R_{\theta JC}$	Thermal Resistance, Junction to Case		1.2	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8460	FDMS8460	Power 56	13"	12 mm	3000 units

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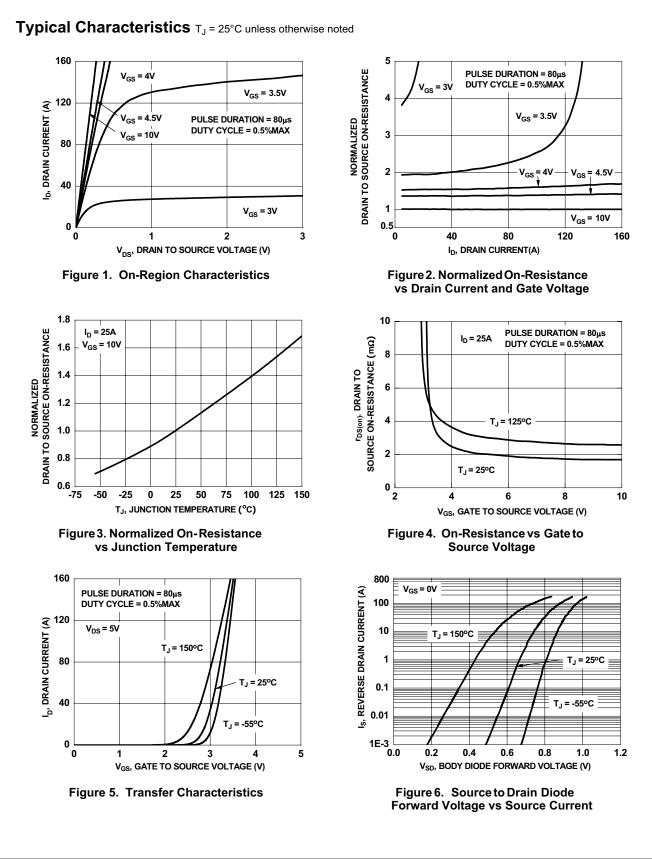
	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	40			V
∆BV _{DSS}	Breakdown Voltage Temperature			22		
ΔT_J	Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$		32		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{DS} = 32V,$			1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.0	1.9	3.0	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage			-		
ΔT_J	Temperature Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$		-7.5		mV/°0
		V _{GS} = 10V, I _D = 25A		2.0	2.2	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 4.5V, I _D = 21.7A		2.6	3.0	mΩ
		V _{GS} = 10V, I _D = 25A, T _J = 125°C		2.6	3.3	1
9 _{FS}	Forward Transconductance	$V_{DD} = 5V, I_D = 25A$		137		S
Dunamia	Characteristics					
-	Characteristics			5415	7205	
C _{iss}	Input Capacitance Output Capacitance	- V _{DS} = 20V, V _{GS} = 0V,		1470	1955	pF pF
C _{oss}	Reverse Transfer Capacitance	f = 1MHz		1470	250	pr pF
C _{rss}	Gate Resistance	f = 1MHz	0.1	1.4	3.1	Ω
R _g Switching	Characteristics		0.1		0.1	
t _{d(on)}	Turn-On Delay Time			19	35	ns
t _r	Rise Time	V _{DD} = 20V, I _D = 25A,		9	19	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 6\Omega$		48	78	ns
t _f	Fall Time			7	14	ns
Q _g	Total Gate Charge	V _{GS} = 0V to 10V		78	110	nC
Q _g	Total Gate Charge	$V_{GS} = 0V \text{ to } 4.5V$ $V_{DD} = 20V,$		36	51	nC
Q _{gs}	Gate to Source Charge	$I_D = 25A$		15		nC
Q _{gd}	Gate to Drain "Miller" Charge			10		nC
•	-					
Drain-Sol	urce Diode Characteristics					
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 25A$ (Note 2)		0.8	1.3	v
	_	$V_{GS} = 0V, I_S = 2.1A$ (Note 2)		0.7	1.2	
t _{rr}	Reverse Recovery Time	— I _F = 25A, di/dt = 100A/μs		53	85	ns
Q _{rr}	Reverse Recovery Charge	•		40	64	nC

2. Pulse Test: Pulse Width < $300\mu s,$ Duty cycle < 2.0%.

3. Starting T_J = 25°C, L = 3mH, I_{AS} = 24A, V_{DD} = 40V, V_{GS} = 10V

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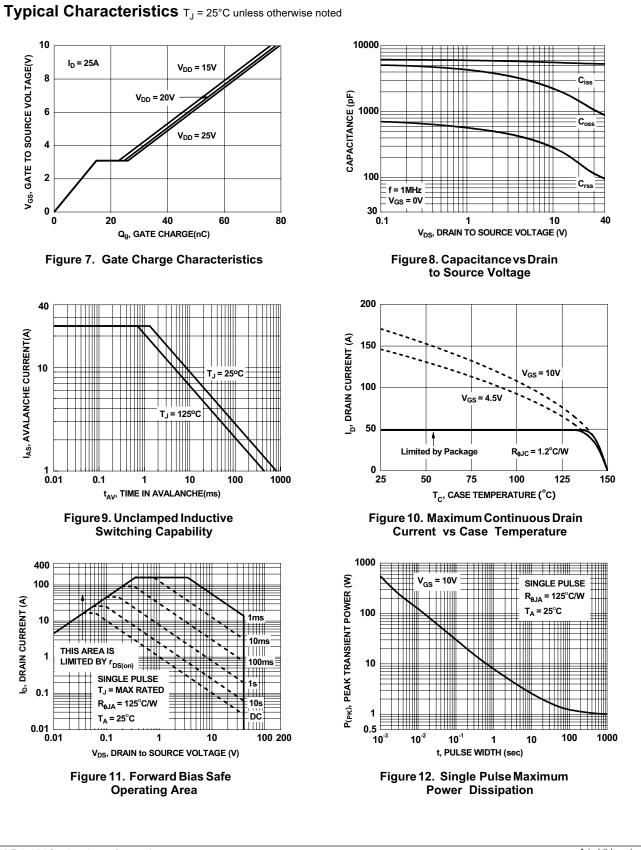
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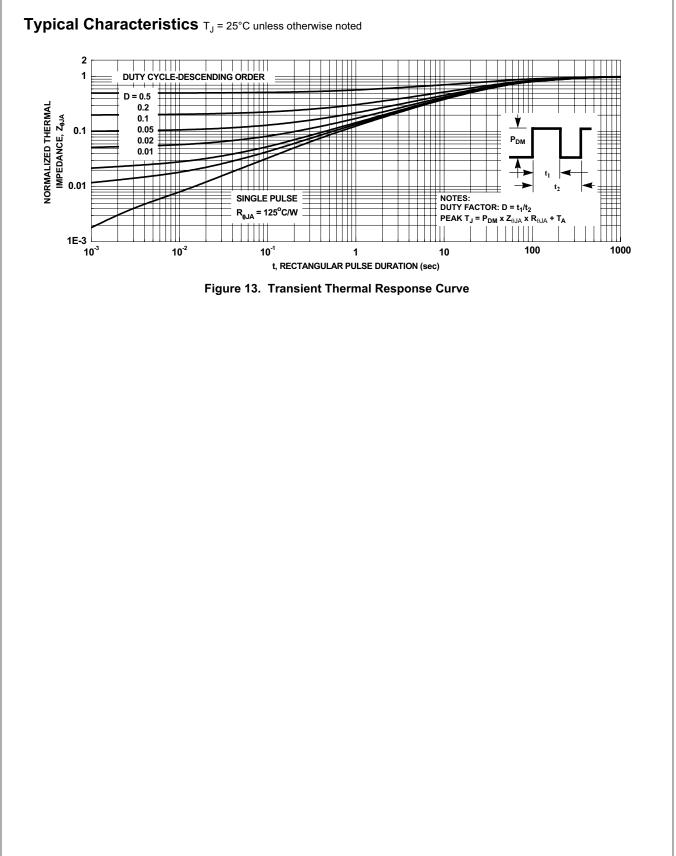
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